

FJP3305

High Voltage Switch Mode Application

- High Speed Switching
- Suitable for Electronic Ballast and Switching Regulator



1.Base 2.Collector 3.Emitter

NPN Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	700	V
V _{CEO}	Collector-Emitter Voltage	400	V
V _{EBO}	Emitter-Base Voltage	9	V
I _C	Collector Current (DC)	4	Α
I _{CP}	Collector Current (Pulse)	8	Α
I _B	Base Current	2	Α
P _C	Collector Dissipation (T _C =25°C)	75	W
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	- 65 ~ 150	°C

Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	I _C =500μA, I _E =0	700			V
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_C=5mA$, $I_B=0$	400			V
BV _{EBO}	Emitter-Base Breakdown Voltage	I _E =500μA, I _C =0	9			V
I _{CBO}	Collector Cut-off Current	V _{CB} =700V, I _E =0			1	μΑ
I _{EBO}	Emitter Cut-off Current	$V_{EB}=9V, I_{C}=0$			1	μΑ
h _{FE1}	* DC Current Gain	V _{CE} =5V, I _C =1A	19		35	
h _{FE2}		V _{CE} =5V, I _C =2A	8		40	
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C =1A, I _B =0.2A			0.5	V
		I _C =2A, I _B =0.5A			0.6	V
		I _C =4A, I _B =1A			1	V
V _{BE} (sat)	Base-Emitter On Voltage	I _C =1A, I _B =0.2A			1.2	V
		I _C =2A, I _B =0.5A			1.6	V
f _T	Current Gain Bandwidth Product	V _{CE} =5V, I _C =1A	4			MHz
C _{ob}	Output Capacitance	V _{CB} =10V, f=1MHz		65		pF
t _{ON}	Turn On Time	V _{CC} =125V,			0.8	μs
t _{STG}	Storage Time	I _C =2A=5I _{B1} =-5I _{B2}			4	μs
t _F	Fall Time	$R_L=62.5\Omega$			0.9	μs

* Pulse test: PW≤300μs, Duty Cycle≤2%

h_{FE} Classification

Classification	R	0
h _{FE2}	19 ~ 28	26 ~ 35

Typical Characteristics

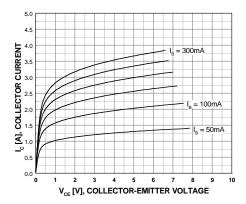


Figure 1. Static Characteristics

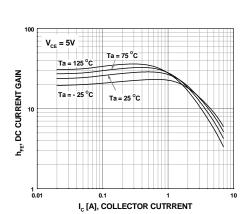


Figure 3. DC Current Gain(O-Grade)

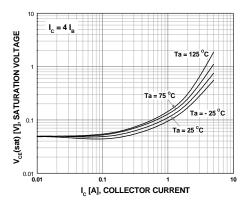


Figure 5. Saturation Voltage(O-Grade)

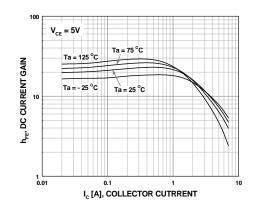


Figure 2. DC Current Gain(R-Grade)

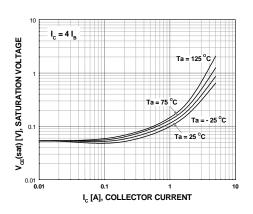


Figure 4. Saturation Voltage(R-Grade)

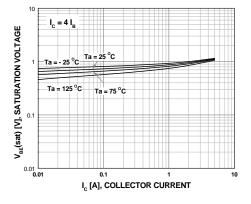


Figure 6. Saturation Voltage(R-Grade)

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Typical Characteristics (Continued)

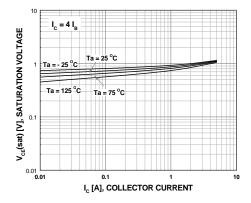


Figure 7. Saturation Voltage(O-Grade)

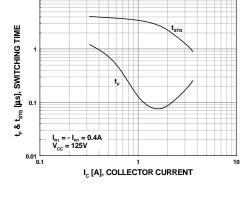


Figure 8. Switching Time

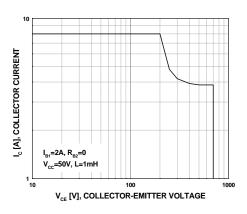


Figure 9. Reverse Biased Safe Operating Area

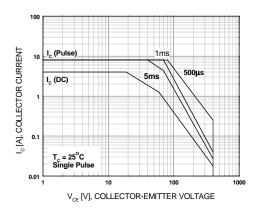


Figure 10. Forward Biased Safe Operating Area

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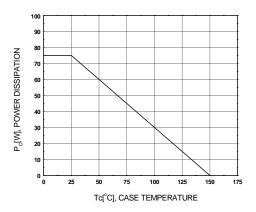
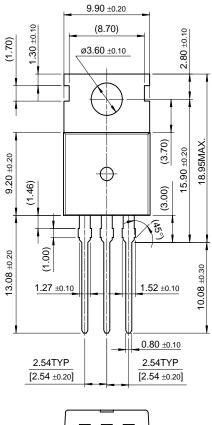


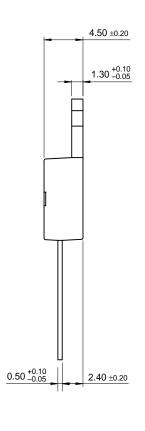
Figure 11. Power Derating

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Package Dimensions

TO-220





10.00 ±0.20

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